# **CERAMIC SMD CRYSTAL**

ABM3C

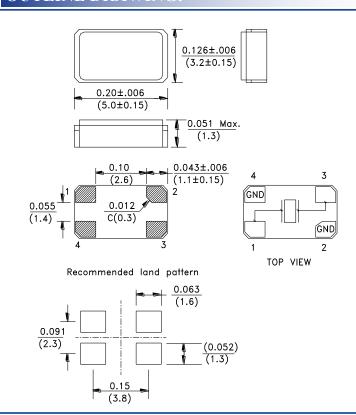
**RoHS/RoHS II Compliant** 





5.0 x 3.2 x 1.3mm

### **OUTLINE DRAWING:**



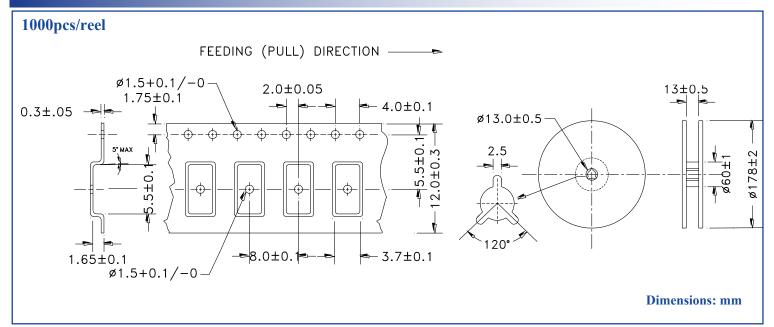
#### **Sealing Method:**

Glass Sealing for parts with Traceability Code ending in "X" Seam Sealing for parts with Traceability Code ending in "C" and "F"

Note: Due to material availability, the chamfer could be located on pin #1 or #2. Be advised that the chamfer location has no impact on the electrical performance of the device.

**Dimensions: inches (mm)** 

#### **TAPE & REEL:**



**REVISED: 09-07-21** 

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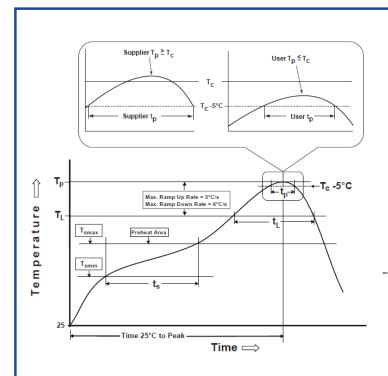
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5.0 x 3.2 x 1.3mm

### **REFLOW PROFILE:**



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Table 2

	Pb-Free Process Classification Temperatures (T <sub>c</sub> )				
-	Package Thickness	Volume mm³ <350	Volume mm <sup>3</sup> 350-2000	Volume mm³ >2000	
	<1.6 mm	260 °C	260 °C	260 °C	
	1.6 mm - 2.5 mm	260 °C	250 °C	245 °C	
	>2.5 mm	250 °C	245 °C	245 °C	

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat / soak		
Temperature minimum (T <sub>smin</sub> )	100°C	150°C
Temperature maximum (T <sub>smax</sub> )	150°C	200°C
Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	60 - 120 sec.	60 - 120 sec.
Average ramp-up rate (T <sub>smax</sub> to T <sub>P</sub> )	3°C/sec. max	3°C/sec. max
Liquidous temperature (T <sub>L</sub> )	183°C	217°C
Time at liquidous (t <sub>L</sub> )	60 - 150 sec.	60 - 150 sec.
Peak package body temperature (T <sub>P</sub> )*	see Table 1	see Table 2
Time $(t_p)^{**}$ within 5°C of the specified classification temperature $(T_c)$	20 sec.	30 sec.
Ramp-down rate (T <sub>p</sub> to T <sub>smax</sub> )	6°C/sec. max	6°C/sec. max
Time 25°C to peak temperature	6 min. max	8 min. max
Reflow cycles	2 max	2 max

<sup>\*</sup>Tolerance for peak profile temperature (T<sub>P</sub>) is defined as a supplier minimum and a user maximum.

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<sup>\*\*</sup>Tolerance for time at peak profile temperature  $(t_p)$  is defined as supplier minimum and a user maximum.